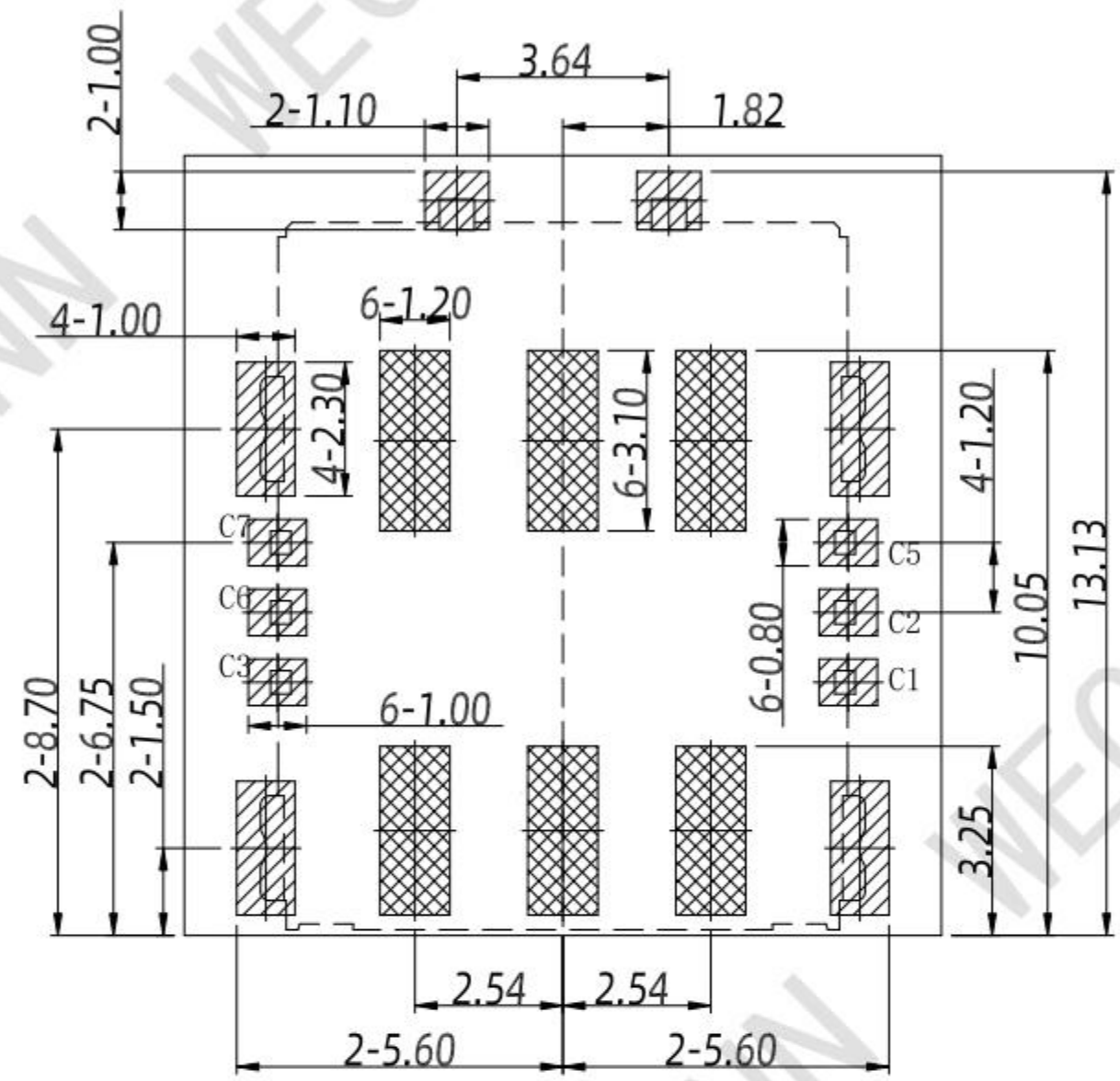
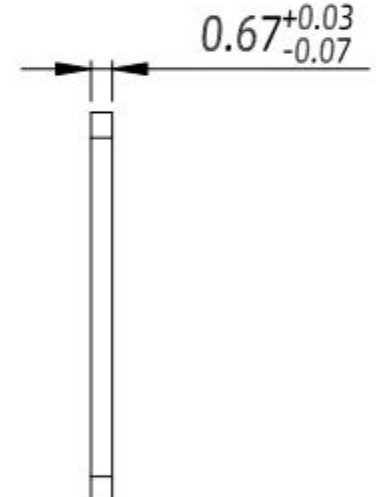
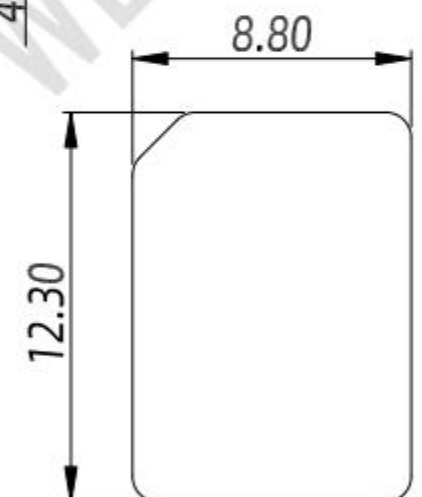
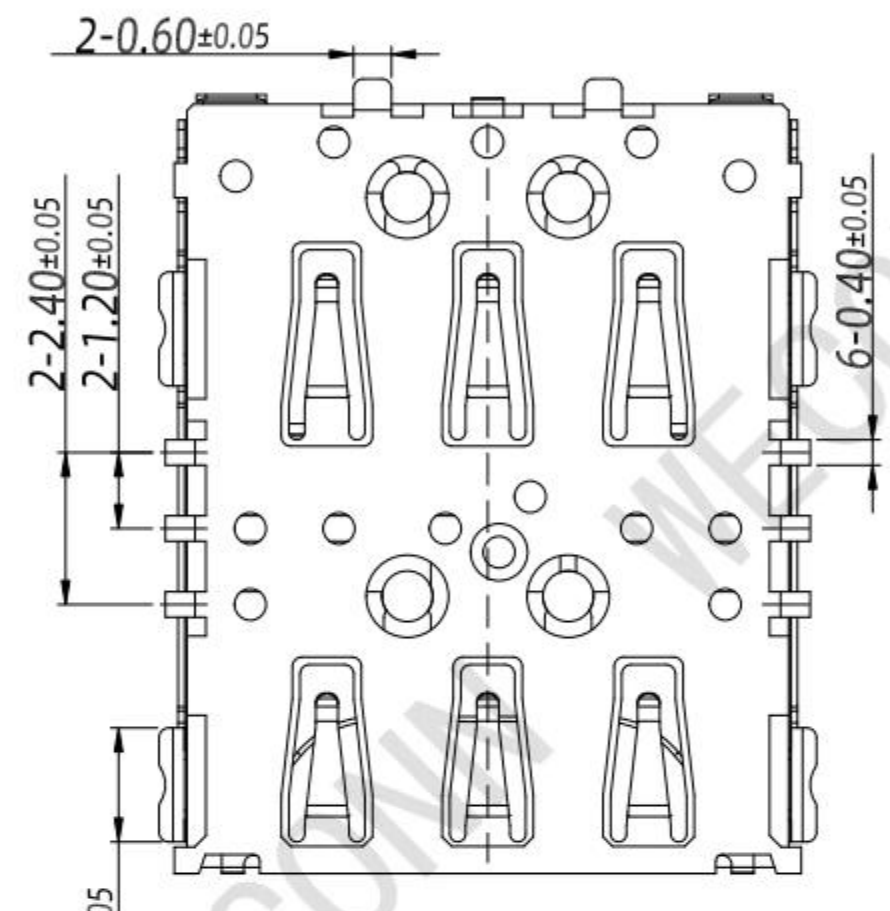
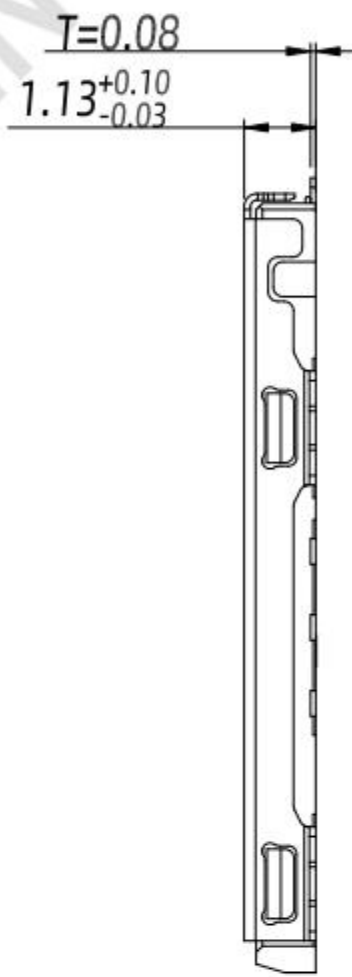
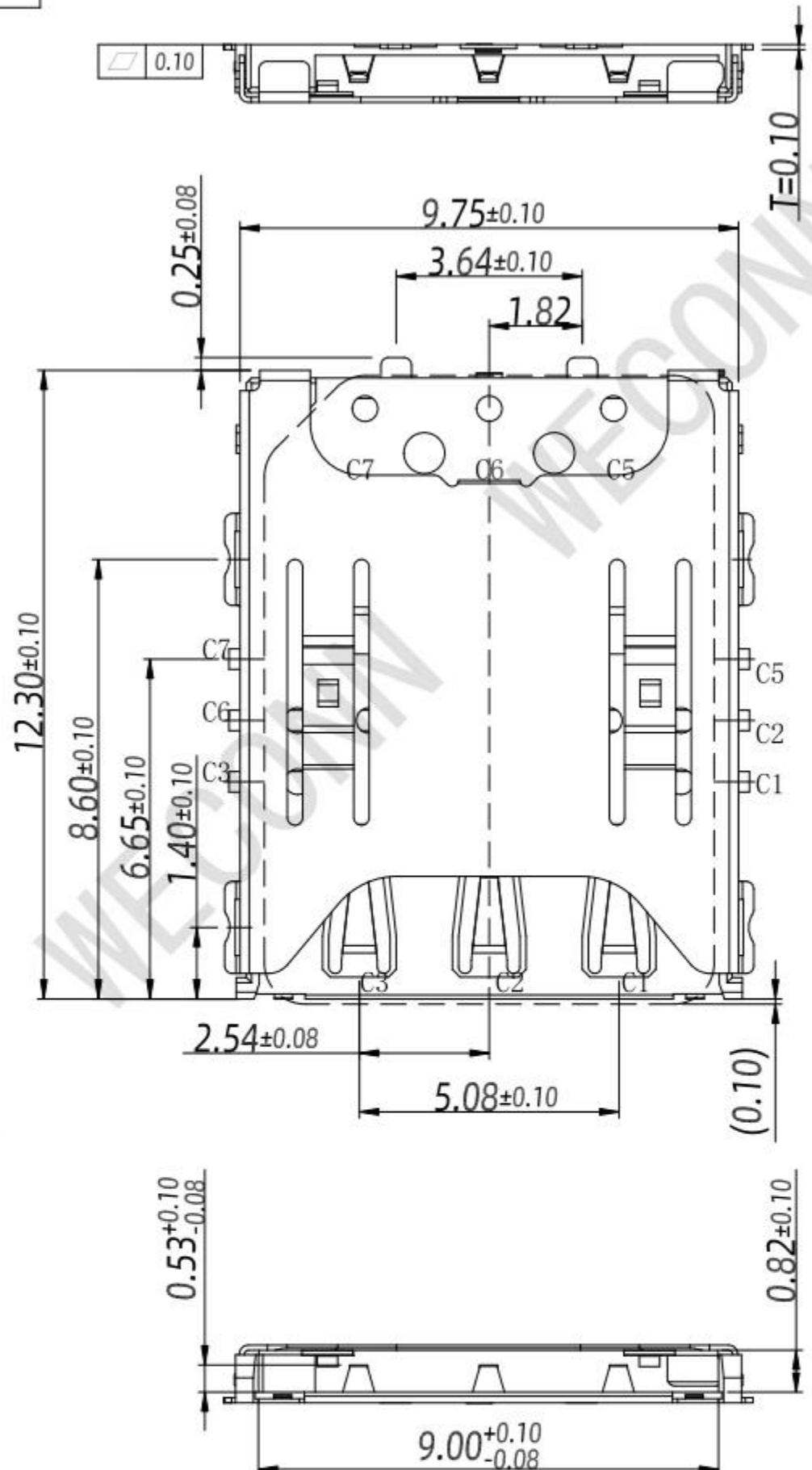


RoHS

REV.	EC#	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A0		NEW RELEASE	2022.06.28	Michael	Mark	Cornelia



RECOMMENDED PCB LAYOUT

TOLERANCE: ±0.05

- SMT SOLDER AREA
- COPPER RESTRICTED AREA
- 1. TOUCH AREA OF CONTACT TIPS NO ELECTRICAL FUNCTION
- 2. NO FIRST PCB_LAYOUT CIRCUITS IN THE AREA

NOTES:
 1. MATERIAL:
 HOUSING: High Temperature Thermoplastic
 Terminal: Copper Alloy
 Shell: Stainless Steel
 2. PLATING:
 Terminal: 50u" Ni UNDERPLATED OVERALL
 G/F PLATED ON CONTACT AREA AND SOLDER AREA
 Shell: 50u" Ni UNDERPLATED OVERALL
 3. TECHNICAL SPECIALITY:
 RATED VOLTAGE: 30VACMAX.
 CURRENT RATING: 0.5AMAX.
 INSULATION RESISTANCE: 1000MΩ
 CONTACT REISTANCE: 100mΩMAX
 WITHSTANDING VOLTAGE: 500VACFOR1MINUTES
 OPERATING TEMPERATURE: -40°C ~ +85°C Humidity 80%R.HMAX

PLEASE CONTACT WELINK SALES REPRESENTATIVE TO VERIFY PRODUCT DETAILS & AVAILABILITY

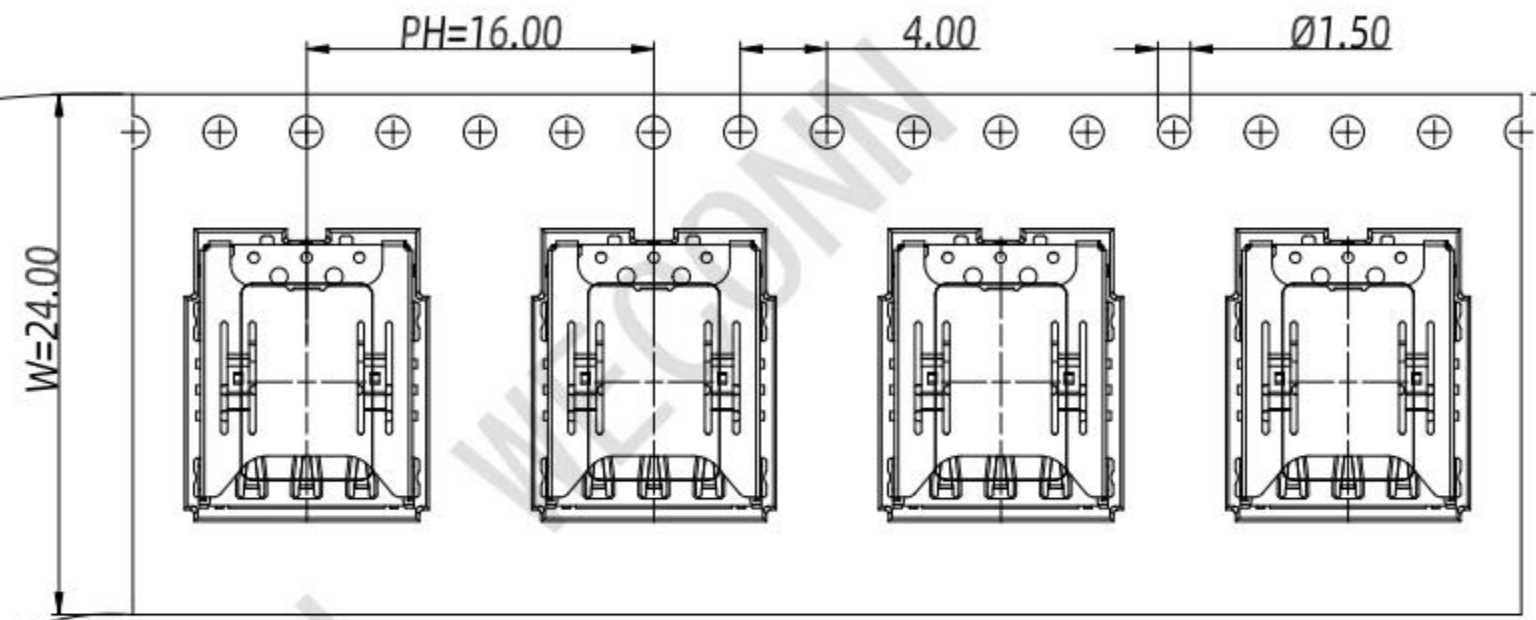
PIN/NO	ASSIGNMENT	MILLIMETERS	INCH
		X. ± 0.2	X.° ± 5°
C1	VCC	.X ± 0.15	.X° ± 2°
C2	RST	.XX ± 0.1	.XX° ± 1°
C3	CLK	.XXX ± 0.01	.XXX° ± 0.5°
C5	GND	THESE DRAWINGS AND SPECIFICATION ARE Welink Shenzhen Welink Electronics Co.,Ltd COPIED OR USED IN ANY MANNER WITHOUT Welink Shenzhen Welink Electronics Co.,Ltd	
C6	VPP		
C7	I/O		

UNITS		WECONN® 深圳市微连电子有限公司	
MM		ShenZhen Welink Electronics Co.,Ltd	
MAT'L	SEE NOTES	PART NUMBER:	TITLE:
FINISH	SEE NOTES	WL-SIM113-052	1.13H NO-PUSH NANO-SIM CARD
QTY	SEE NOTES	DWG NO.:	APPD: Cornelia
		WL-SIM113-052	CHKD: Mark
		SCALE SHEET REV.	DR: Michael
		1:1 1/2 A1	

RoHS

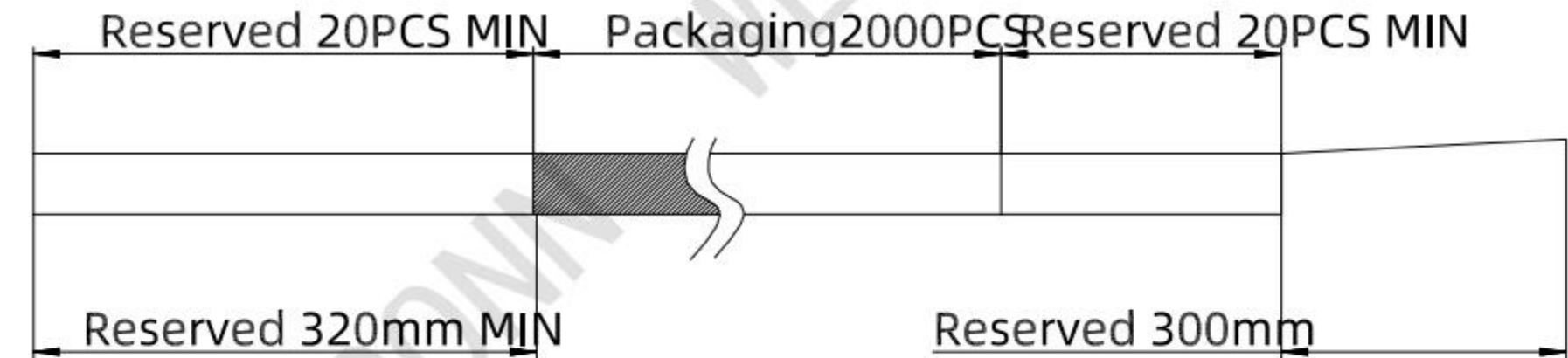
REV.	EC#	DESCRIPTION	DATE	DRAWING	CHECKED	APPROVED
A0		NEW RELEASE	2022.06.28	Michael	Mark	Cornelia

Direction of use →



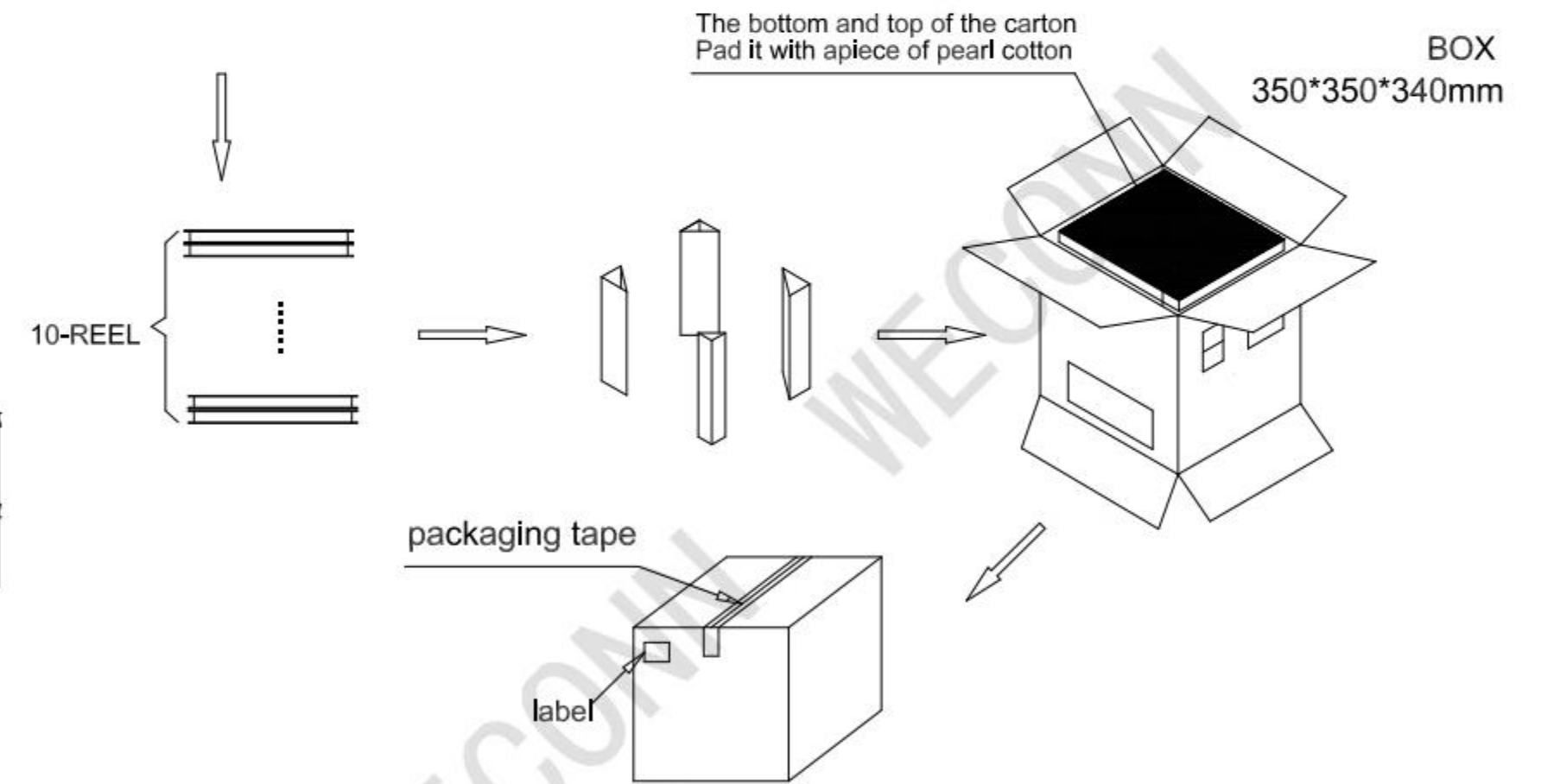
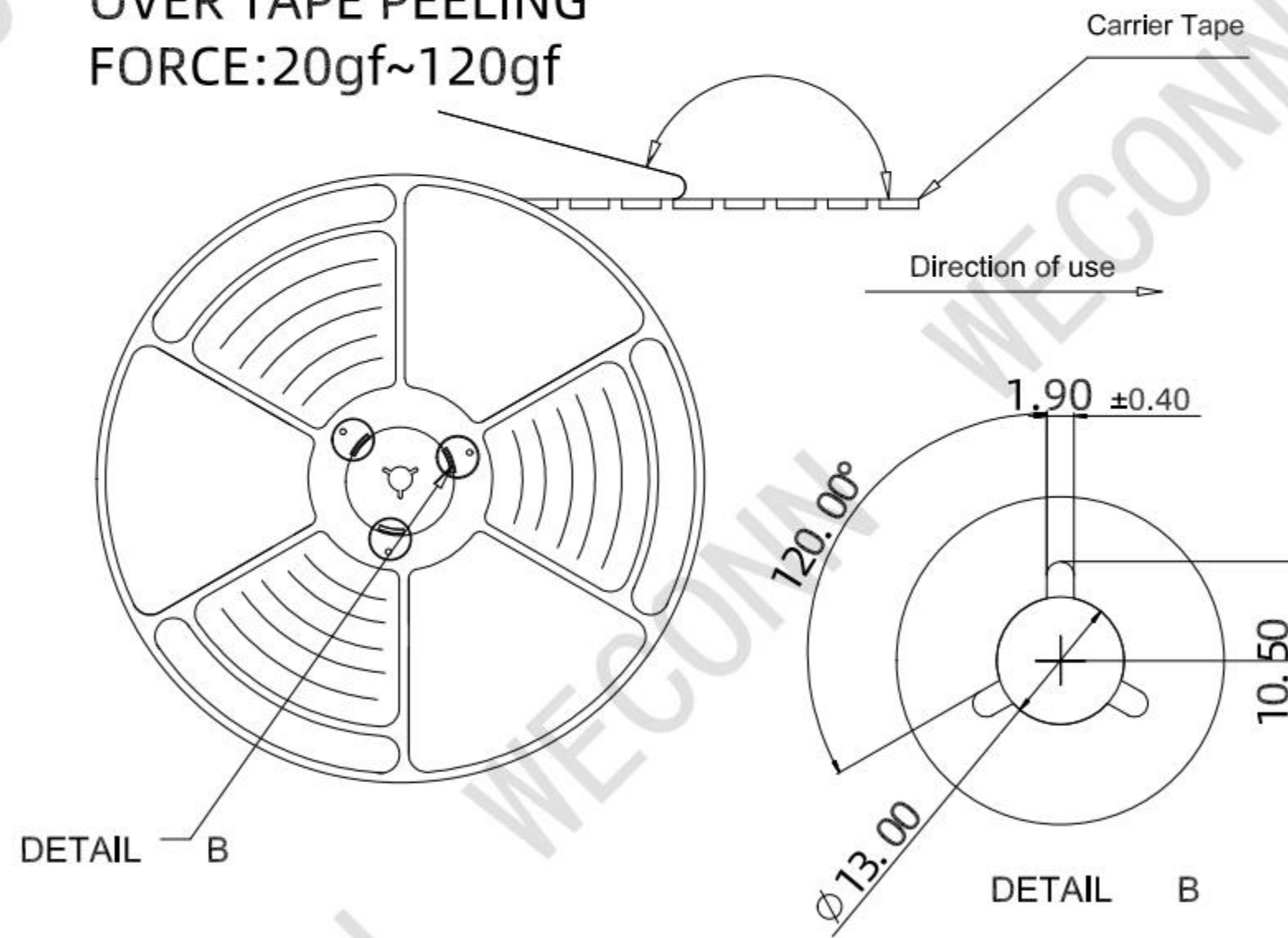
NOTES:

- 1、 Packing quantity per plate: 2000PCS/Plate
- 2、 Loading and packing method



- 3、 Total packaging: 20000PCS/Box

OVER TAPE PEELING
FORCE: 20gf~120gf



MILLIMETERS	INCH	UNITS
X. ± 0.2	X.° ± 5°	MM
.X ± 0.15	.X° ± 2°	MAT'L SEE NOTES
.XX ± 0.1	.XX° ± 1°	FINISH SEE NOTES
.XXX ± 0.01	.XXX° ± 0.5°	QTY SEE NOTES

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PART NUMBER: WL-SIM113-052		TITLE: 1.13H NO-PUSH NANO-SIM CARD	
DWG NO.: WL-SIM113-052		APPD:	Cornelia
SCALE 1:1	SHEET 2/2	CHKD:	Mark
REV. A1		DR:	Michael